



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

Y. MIYAKI, et al.

Application No.:

09/785,452

Filed:

February 20, 2001

For:

SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE

AND METHOD OF MANUFACTURING THE SAME

Art Unit:

2827

Examiner:

L. Cruz

UNDER 37 CFR §§ 1.97 AND 1.98

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 June 23, 2003

Sir:

In the matter of the above-identified application, applicants are submitting herewith a copy of a communication from a foreign patent office in a counterpart foreign application and copies of the documents listed in the attached form equivalent to Form PTO-1449 for the Examiner's consideration.

This Information Disclosure Statement is being submitted after the mailing date of a first office action, however, it is being submitted within three months of the foreign report and therefore no fee is required. Further, the Applicants provide the following certification specified in 37 CFR 1.97(e):

On information and belief, I hereby certify that no item of information in the information disclosure statement filed herewith was cited in a communication from a foreign patent office in a counterpart foreign application or, to my knowledge after making reasonable inquiry, was known to any individual designated in § 1.56(c) more than three months prior to the filing of this information disclosure statement.

To the extent the documents listed on the attached form equivalent to Form PTO-1449 are not in the English language, the requirement of 37 CFR § 1.98(a)(3) for a concise explanation of the relevance is satisfied by an English language translation of pertinent portions of the foreign language documents.

It is respectfully requested that this information disclosure statement be considered by the Examiner.

Please charge any shortage in the fees due in connection with the filing of this paper, including extension of time fees, to the deposit account of Antonelli, Terry, Stout & Kraus, Deposit Account No. 01-2135 (500.39590X00) or credit any excess fees to such deposit account.

Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP

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Attachment: Form PTO-1449

Search Report

PTO/SB/08A (10-01) Approved for use through 10/31/2002. OMB 0651-0031

U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE

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Substitute for form 1449A/PTO			Complete if Known				
	_			Application Number	09/785,452		
	INFORMATION DISCL	_OS	URE	Filing Date	February 20, 2001		
1	STATEMENT BY APP	LIC	ANT	First Named Inventor	Y. MIYAKI, et al.		
				Art Unit	2827		
	(use as many sheets as nee	çessa	(y)	Examiner Name	L. Cruz		
Sheet	1	of	1	Attorney Docket Number	500.39590X00		

U.S. PATENT DOCUMENTS						
Examiner Initials	Cite No.1	Document Number Number-Kind Code ² (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	
		US- 5,929,511	07-27-1999	Nakazawa et al		

		FOREIG	N PATENT DO	CUMENTS		
Examiner	Cite	Foreign Patent Document	Publication Date	Name of Patentee or	Pages, Columns, Lines,	
initials'	No.1	Country Code ³ –Number ⁴ –Kind Code ⁵ (<i>if known</i>)	MM-DD-YYYY	Applicant of Cited Document	Where Relevant Passages or Relevant Figures Appear	T ⁶
		JP 61-140160	06-27-1986	Hitachi Cable Ltd.		Abst
		JP 11-307710	11-05-1999	Matsushita Electric Ind Co Ltd		Abst

		OTHER PRIOR ART—NON PATENT LITERATURE DOCUMENTS
Examiner Initials*	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s),
		3 3
		5. 3

Examiner	Date	-	
Signature	Considered	L	

Burden Hour Statement: This form is estimated to take 2.0 hours to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant

¹Applicant's unique citation designation number (optional). ²See Kinds Codes of USPTO Patent Documents at www.uspto.gov or MPEP 901.04. ³Enter Office that issued the document, by the two-letter code (WIPO Standard St.3). ⁴For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. ⁵Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. ⁶Applicant is to place a check mark here if English language Translation is attached.



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RF 206

In Reply Please Quote Our Reference

Your Ref

M313KC 15TN/PAT/8104174/59

Our Ref

200100859-8

Date

Writer's Direct Line

03/0A/03

Drew & Napier Rebinson Road P O Box 152 Singapore 900302

Dear Sir,

Singapore Patent Application No.:

200100859

Title of invention:

Applicant(s):

Hitachi, Ltd.

SEARCH REPORT (Supprementary)

The Search Report for this application has been established and a copy of it is attached. This application will proceed to publication in accordance with section 27 of the Patents Act (Cap. 221).

Your attention is drawn to the provisions of the Patents Act and Rules (Cap. 221 and R-1) for action that may be - taken in relation to the search report received.

If you have any further queries, please do not hesitate to contact the undersigned.

Thank you.

Yours faithfully,

Annie Besant d/o Surendran for REGISTRAR OF PATENTS

SINGAPORE







Austrian Patent Office Service and Information Sector (TRF)

To REGISTRY OF PATENTS 51 Bras Basah Road #04-01 Plaza By The Park SINGAPORE 0718	3	Kohlmarkt 8-A - 1014 AE Austria Tel.No.: ++44 Fax.No.: ++44 Date of maili	NNA 31/53424/0 31/53424/520
Applicant HITACHI, LTD. Application No.	Filing Date		(Earliest) Priority Date
200100859-8	16 February 2001	l (16.02.2001)	18 February 2000 (18.02.2000)
International Patent Classification (IPC		495, 23/49	
Please find enclosed the	SEARCH REPOI		
	WRITTEN OPIN	IION	
provided by the Austrian Patent Off Understanding between the Governi			
	<u>-</u>		Best regards
AUSTRIAN PATENT (Service and Informa Sector TRF			Dr. Flammer
the examination the written opin	npanied by a copy of ea report		nt cited in the report)

Austrian Patent Office

Application No. 200100859-8	Applicant: HITACHI, LTD.
Filing date 16 February 2001 (16.02.2001)	(Earliest) Priority Date 18 February 2000 (18.02.2000)

GENERAL OBSERVATIONS

- ☑ This search report has been drawn on the basis of the "Request for a Search Report or Supplementary Search Report" dated 11 June 2002 and is established for the requested claims Nos.14-17.
- ☑ With regard to the abstract the text is approved as submitted by the applicant.
- ☑ The application contains neither statements disparaging any person nor expressions etc. contrary to morality or the public order.
- ☑ Unity of invention is given.

AUSTRIAN PATENT OFFICE Kohlmarkt 8-10, A-1014 VIENNA Facsimile No. ++431/53424/535 Authorized Officer

STEPANOVSKY M.



Kohlmarkt 8-10, A-1014 VIENNA Facsimile No. ++431/53424/535

SEARCH REPORT

Application No. 200100859-8

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	CATION OF SUBJECT MATT International Patent Classification (IPC ⁷): H01L		
B. FIELDS SI	EARCHED IPC ⁷ :	H01L, C23C	
	ase consulted during the search (name of co., STN-PATDPA, DEPATISNET	data base and, where practicable, search terms	s used)
C. DOCUME	NTS CONSIDERED TO BE RE	LEVANT	
Category *		where appropriate, of the relevant passages	Relevant to claim No.
A		A et al.) 27 July 1999 (27.07.99) 1-3, abstract.	14-17
А		HI CABLE LTD.) 1986-06-27. stract of Japan.	14-17
А		SHITA ELECTRIC IND. CO. LTD.) ent abstract of Japan	14-17
☐ Further docu	nments are listed in the continuation of Bo	ox C. See patent family annex.	
"A" document de considered t "E" earlier docur "L" document w or which is	ories of cited documents: fining the general state of the art which is not to be of particular relevance ment but published on or after the filing date which may throw doubts on priority claim(s) cited to establish the publication date of the cited of other special reason (as specified)	 "T" later document published after the filing dat conflict with the application but cited to un theory underlying the invention "X" document of particular relevance; the claim considered novel or cannot be considered to when the document is taken alone "Y" document of particular relevance; the claim considered to involve an inventive step wh combined with one or more other such doc 	derstand the principle or ed invention cannot be o involve an inventive step ed invention cannot be en the document is
or other mea "P" document pu the priority d	blished prior to the filing date but later than	being obvious to a person skilled in the art "&" document member of the same patent famil	
AUSTRIAN PA		Authorized Officer STEPANOVSK	Y M.

Telephone No. ++431/53424/ 135



Austrian Patent Office

Application No. 200100859-8	Applicant HITACHI, LTD.	
Filing date 16 February 2001 (16.02.2001)	(Earliest) Priority Date 18 February 2000 (18.02.2000)	

SEARCH REPORT

EXPLANATIONS

US 5929511 A:

The lead frame includes main body that consists of copper material on which a nickel layer, a palladium layer and a metal layer are formed in an order. The main body includes a die pad, a suspension lead, an inner lead, a tie rod, an outer lead and a frame. The main body includes a sealing member by which main body is sealed using a sealing resin. The sealing resin is guided to the sealing member using a gate runner. The metal layer is not formed at least at one part of gate runner.

JP 61-140160 A2:

To contrive the reduction of cost and the improvement of reliability by a method wherein an Ni alloy layer having one or more elements of B, P, Fe, and Co is provided on a metallic substrate, and the semiconductor element fixing part and inner lead terminals are provided with Pd or Pd-Ni alloy platings. The substrate punched out of a copper strip is provided with a Ni-Fe alloy plated layer as the base layer over the whole by electroplating. Further, Pd plated layers are partly provided thereon at the mechanical part including the semiconductor element fixing part and inner lead terminals. A Si pellet is brazed on the Pd plated layer with an Ag paste solder at the semiconductor element fixing part, and the Si pellet is wired to the inner lead terminals of the lead frame with Au fine wires. Thereafter, an IC package is constructed by sealing the whole with a resin.

JP 11-307710 A2:

The lead frame is formed by nickel or nickel alloy, copper or copper alloy and iron, or ferrous metal. The surface layer containing silver is provided in an inner lead and the surface layer containing silver and tin in outer lead.



SEARCH REPORT

Information on patent family members

Application No.

200100859-8

This annex lists the patent family members relating to the patent documents cited in the search report. The members are as contained in the EPIDOS INPADOC file.

The Office is in no way liable for these particulars which are merely given for the purpose of information

Patent document cited in search report				Patent f memb		Publication date
US A	5929511	27-07-1999	JP JP	A2 B2	10084066 3288263	31+03-1998 04-06+2002
JP A2	61140160	27-06-1986			none	
JP A2	11307710	05-11-1999	US	A	6087714	11-07-2000
			J?	A.2	00164782	16-06-2000